



SMART Sensor Series

Laser Displacement Sensor CMOS Type

Model ZX2 Series

Stable, Easy & Affordable

New Regular-reflective Sensor Head
Designed for Optimal Wafer Measurement



realizing

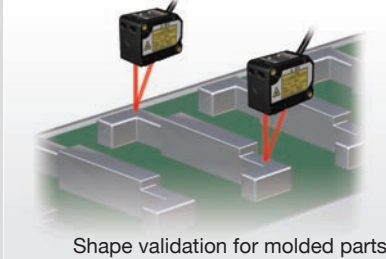
One Solution for Any Application

Height/Length



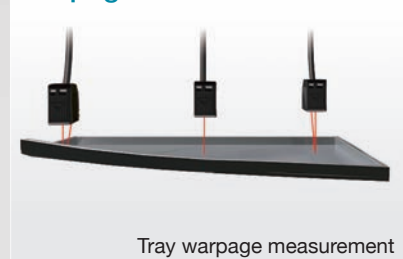
Thin connector assembly

Level detection



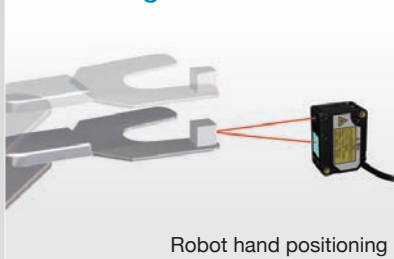
Shape validation for molded parts

Warpage



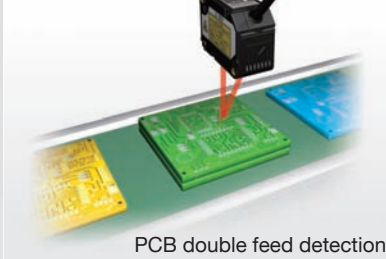
Tray warpage measurement

Positioning



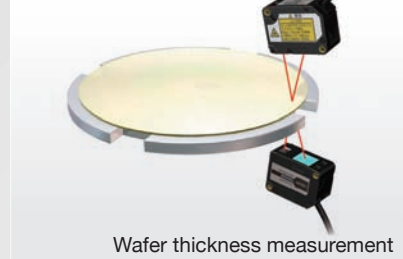
Robot hand positioning

Double feed



PCB double feed detection

Thickness



Wafer thickness measurement

New

Laser Displacement Sensor CMOS Type

ZX2 Series

Realize stable measurements

Resolution $1.5\mu\text{m}$ ^{*1}

Reliable measurement of moving objects

**Measurement cycle
30 μs**

Stable Wafer Measurement

**Regular-reflective
Sensor Head**

Realize stable measurements at $10\mu\text{m}$

Linearity^{*2} $\pm 0.05\% \text{ F.S.}$ ^{*3}

Unaffected by environmental changes

**Temperature characteristic^{*4}
0.02% F.S./ $^{\circ}\text{C}$ ^{*5}**

^{*1} When employing Models ZX2-LD50/LD50L (50mm type)

^{*2} Linearity : Maximum error produced when measuring within measurement range

^{*3} A linearity of $\pm 0.05\% \text{ F.S.}$ indicates that the maximum error is $\pm 10 \mu\text{m}$ when the ZX2-LD50L is used with a 40 to 50-mm measurement range, or $\pm 35 \mu\text{m}$ when the ZX2-LD100L is used with a 65 to 100-mm measurement range.

^{*4} Temperature characteristic : Error produced when the ambient temperature varies by 1°C

^{*5} Linearity $\pm 0.02\% \text{ F.S.}/^{\circ}\text{C}$ indicates the maximum error is $4 \mu\text{m}$ when the ambient temperature varies by 1°C in the case of using Models ZX2-LD50/LD50L with a measurement range $\pm 10\text{mm}$.



Stable Measurement and Easy to Use

Stability

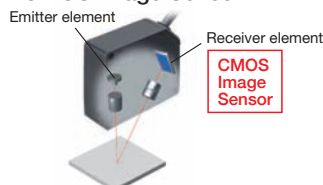
Stable measurements in case of color/material and moving objects

Dynamic range of two million times

Stable measurements are enabled for any color or surface condition, including metals, substrates, elastomers, and transparent materials, through OMRON's unique HSDR-CMOS (High Speed and Dynamic Range) image sensor and a step-less laser power adjustment algorithm.

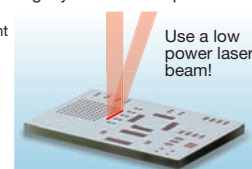
A line beam is used in addition to an emitter beam when dealing with rough surfaces to average out the amount of reflected light and to offset the amount of light received at a high-speed measurement period of 30 μ s in order to reduce variations in received light and to enable stable measurements for moving objects.

CMOS Image Sensor

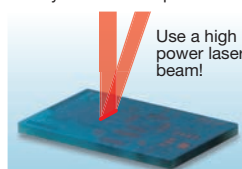


Step-less adjustment of laser power

For high reflectance, brightly colored workpiece



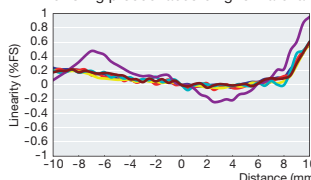
For low reflectance, darkly colored workpiece



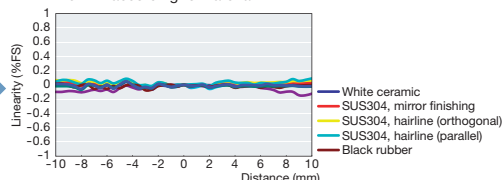
Patented^{*1}

Stable measurements on objects with changing color/material

Linearity characteristic of existing product according to material

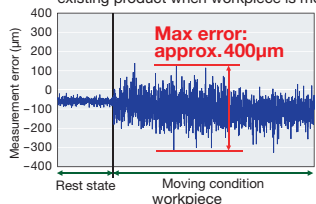


Linearity characteristic of the ZX2 according to material

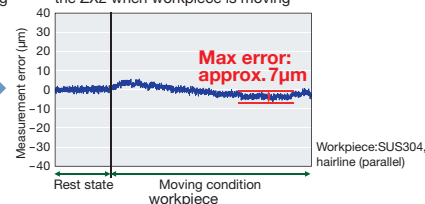


Stable measurements on moving objects

Limit of resolution of existing product when workpiece is moving



Limit of resolution of the ZX2 when workpiece is moving



Note. The resolution, angle characteristic, measuring range, linearity, spot diameter, and other specifications differ among models. Refer to *Ratings and Specifications* for details. The linearity indicates the error with respect to the ideal straight line of the displacement output in the case of measuring Omron's standard target object. Linearity and measured value may vary depending on target object. Before final installation, test the sensor required for the application to validate that the desired measurements have been obtained.

*1. "Patented" means that we obtained a patent in Japan. (As of October 2019)

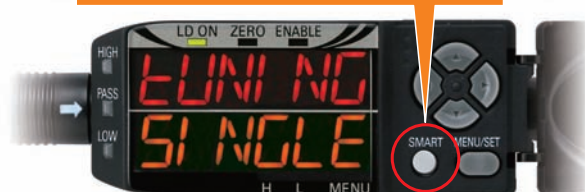
Easy

Easy and User-friendly Configuration

Smart tuning

The ideal configuration for stable measurements is realized by a single button through the new feature "smart tuning", and no longer depends on the skill of the user. A reliable configuration is achieved by three tuning methods, which can be selected to match the type of object and surface conditions to be measured.

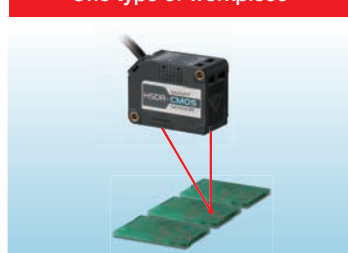
Sensor configuration by just a pushing the SMART button



Patented^{*1}

Three selectable tunings

One type of workpiece



Single smart tuning

Best configuration for stable detection in case of objects do not change by pushing the button for one second

Several types of workpiece



Multi-smart tuning

Ideal configuration for stable detection of changing objects by pushing the button for three seconds

Surface conditions of the workpiece are variable



Active smart tuning

Continuous configuration improvement for the stable detection of all locations by pushing the button for five seconds

Sensor Heads for Various Applications-select the Range and Type of Beam

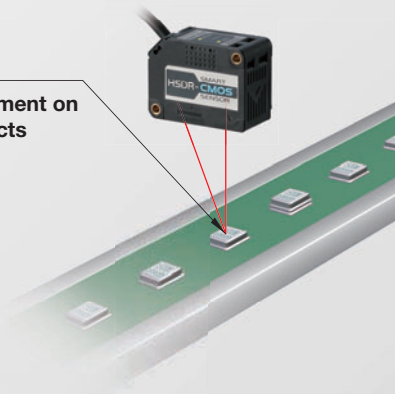
New Regular-reflective Sensor Head Designed for Optimal Wafer Measurement

ZX2-LD50L Line beam type ZX2-LD50 Spot beam type

● Measurement range	50mm±10mm
● Resolution	1.5μm
● Linearity	Line beam ±0.05%F.S.* ¹ Spot beam ±0.10%F.S.* ¹
● Beam size	Line beam Approx.60μm×2.6mm Spot beam Approx.60μm dia.

Spot beam

Precise measurement on micro-scale objects

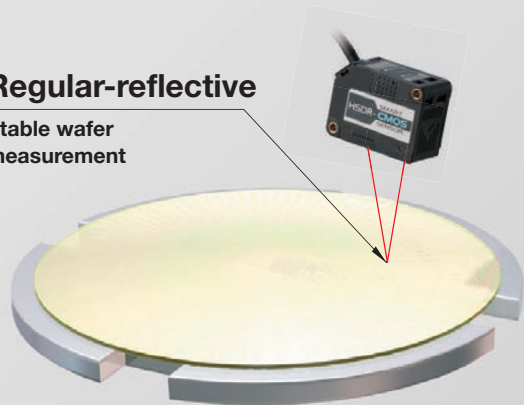


ZX2-LD50V Spot beam type (regular-reflective)

● Measurement range	48mm±5mm
● Resolution	1.5μm
● Linearity	Spot beam ±0.3%F.S.
● Beam size	Spot beam Approx.60μm dia.

Regular-reflective

Stable wafer measurement

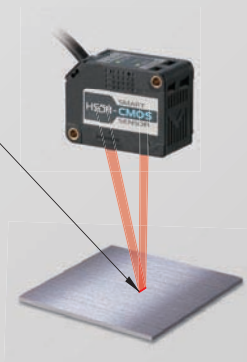


ZX2-LD100L Line beam type ZX2-LD100 Spot beam type

● Measurement range	100mm±35mm
● Resolution	5μm
● Linearity	Line beam ±0.05%F.S.* ² Spot beam ±0.10%F.S.* ²
● Beam size	Line beam Approx.110μm×2.7mm Spot beam Approx.110μm dia.

Line beam

Stable measurement on rough-surfaced objects



*¹ Using 40 to 50mm
*² Using 65 to 100mm



Support for Various Environments/Space-Saving ●●● The Smart Sensor Head

Reliable measurements in harsh environments

IP67, robot cable
& temperature characteristic 0.02% F.S./°C

IP67 protection class enables to use the sensor in harsh environments. A robot cable is used as standard between the head and amplifier, that the unit can be used reliably on moving parts. In addition, as 3D UV bond is used to fix the optical components rather than screws, stress can be controlled and a temperature characteristic 0.02% F.S./°C* is realized.

* If the room temperature varies 1°C, the measured value varies 0.02% F.S.
(corresponding to 4µm for the Model ZX2-LD50)

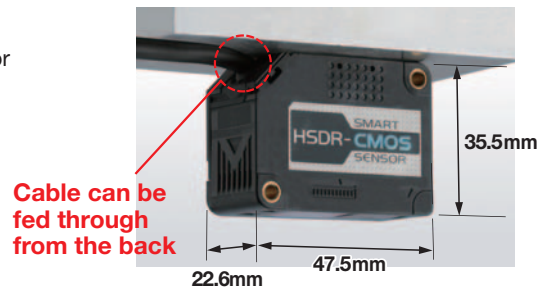


Compact sensor for easy mounting

World smallest*

The world's smallest CMOS laser displacement sensor head is realized in a resin case. Enables to mount the sensor in smallest spaces and to minimize measurement errors arising from temperature fluctuations.

* According to OMRON investigation of CMOS laser displacement sensors performed in September 2010.



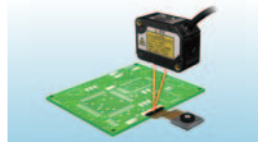
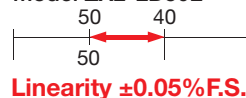
10µm precision measurements

Linearity to meet the application

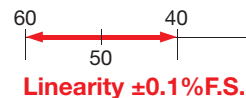
Measurements to an even higher accuracy are realized for applications that do not require the entire measurement range. If the range of the field is less than the length of the measurement center, linearity accuracy improves by 50% compared with that for the full range.*

* For the ZX2-LD50L/LD100L.

Model ZX2-LD50L



Example of an application that does not require the entire measurement range
Low-profile connector assembly height measurement



Example of an application that requires the entire measurement range
Robot hand registration

Visualization to prevent from stopping the production-line

Laser life display function

The end of the laser diode lifespan is automatically detected and displayed so maintenance can be performed systematically. On the main digital display of the amplifier, this is indicated by an LED on the back of the head. Accordingly, in case of amplifier is within the control panel, the lifetime can be confirmed by the head and the indications are not missed.

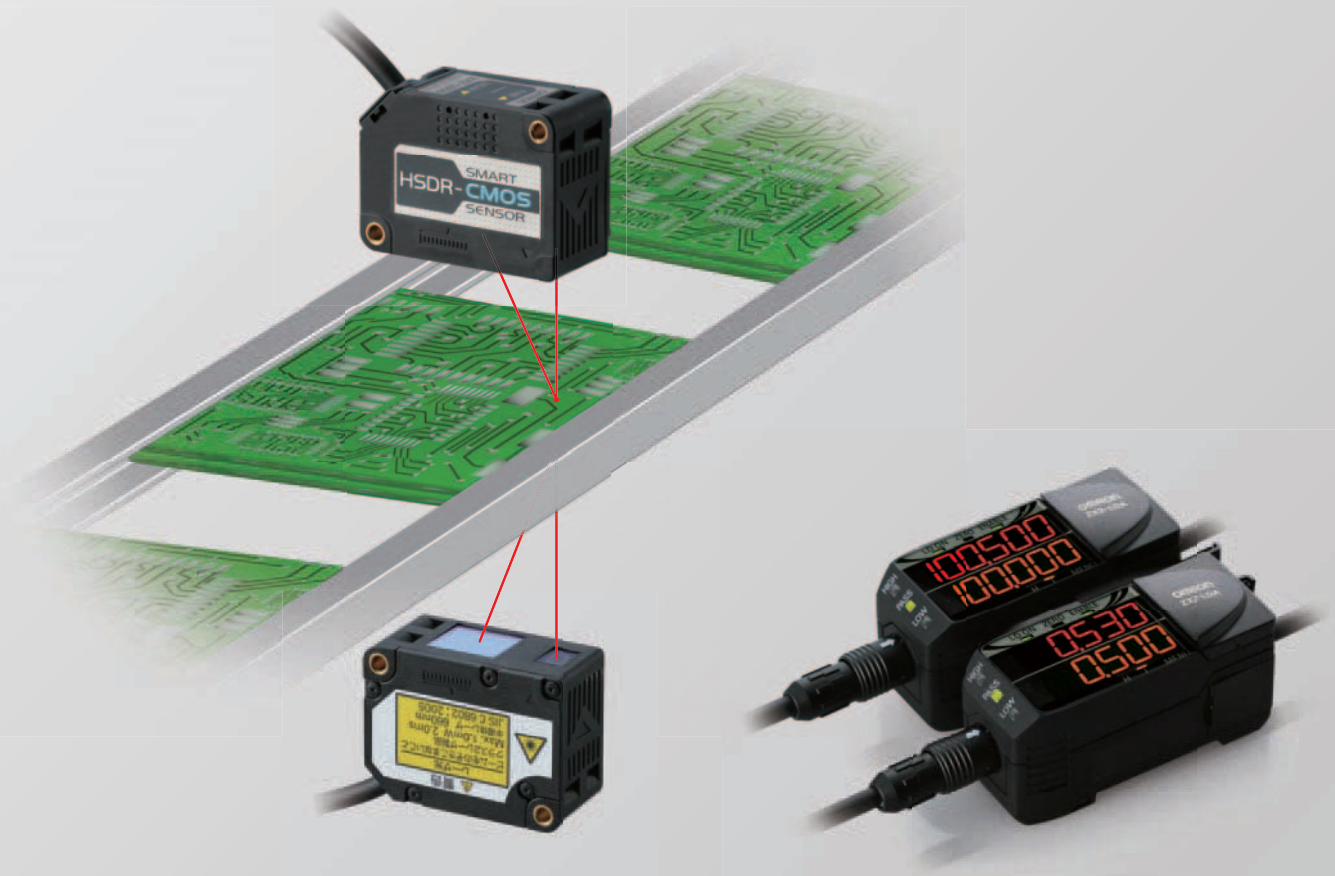


Ease of Use by “LED Display” and “Calculating Unit”

11-segment LED display for intuitive configuration



Easy calculations of measurements





A thorough pursuit of user-friendliness ●●● The Smart Amplifier Unit

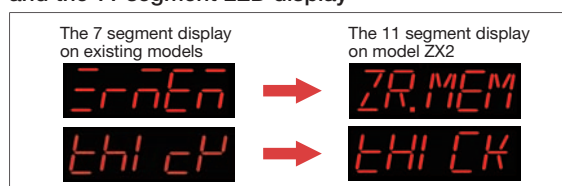
No need for a manual

11 Segment LED Display

An 11 segment LED display is integrated in the compact housing. Alphanumeric characters can be read with ease and there is no need to refer to a manual.



Comparison of the existing 7 segment LED display and the 11 segment LED display

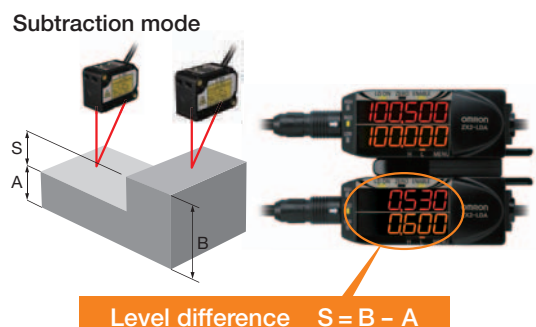
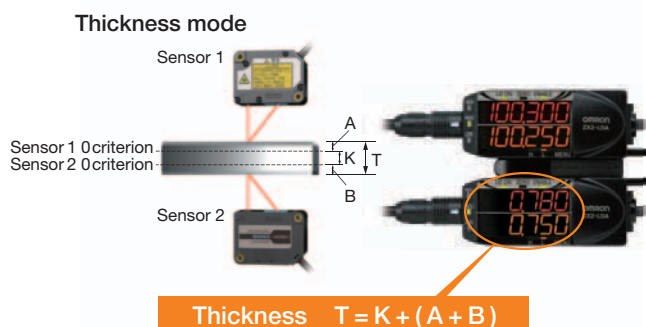


The compact housing stays just as it is

Perform two calculations with ease

Thickness + subtraction mode

The calculated results of two sensor heads are displayed on the amplifier unit by just connecting the calculating unit between the two amplifier units. The calculation function can be chosen from the two modes of thickness and subtraction. It is also possible to prevent mutual interference by coupling via the calculating units. (Up to five amplifier units can be connected.)

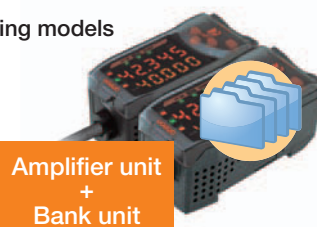


Easy change of setup

Equipped with 4 banks

The amplifier unit is equipped with four bank functions. Easy change of setup between four modes is supported by just switching between the bank functions.

Existing models



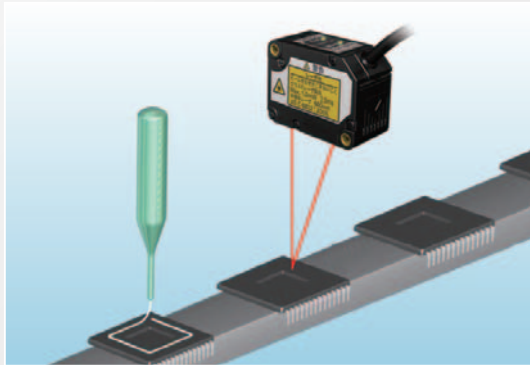
ZX2



One Sensor for Any Measurement Application

Height/ Length

Height measurements prior
to IC package sealing

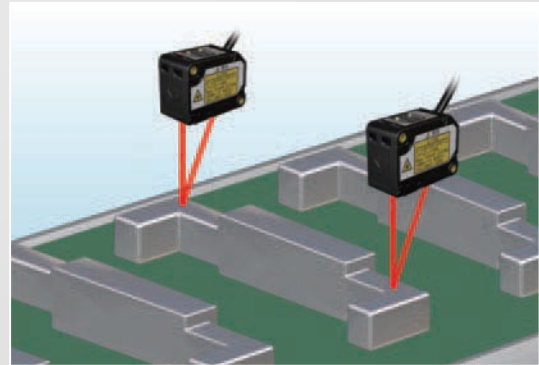


Point

Stable measurements can be performed by the HSDR-CMOS image sensor and Omron's proprietary algorithm, even for measurements on moving IC packages.

Level detection

Shape validation
for molded parts

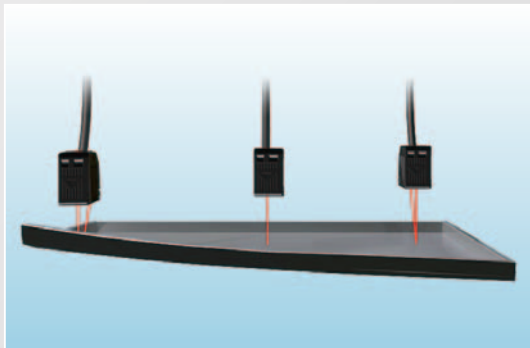


Point

Calculation of the measured values can be carried out and the difference in level can be easily measured by just connecting the calculating unit between two amplifiers. Even if the surface conditions of a molded part varies, application of a line beam and HSDR-CMOS image sensor results in almost no fluctuation in measured value.

Warpage

Tray warping measurement
before chip baking

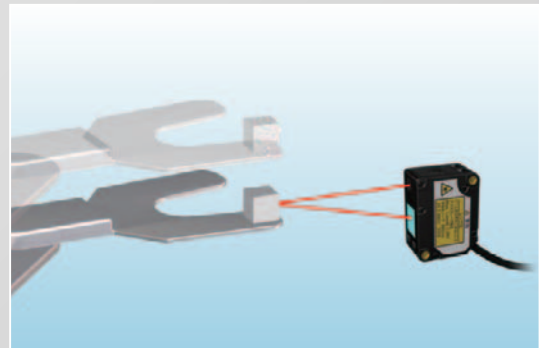


Point

Even if there is temperature variation due to the ambient temperature, a die-cast is used for the optical base and so there is almost no fluctuation in measured value.

Positioning

Robot hand Positioning

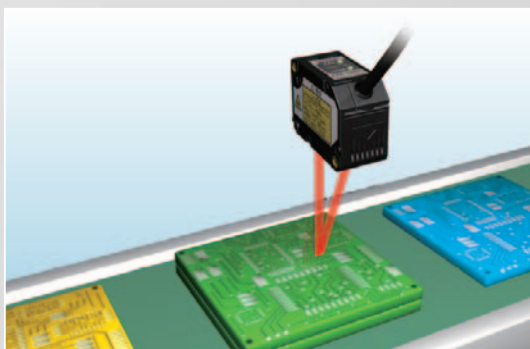


Point

Stable measurements can be performed by the HSDR-CMOS image sensor and Omron's proprietary algorithm even for robot hand registration.

Double feed

PCB double feed detection

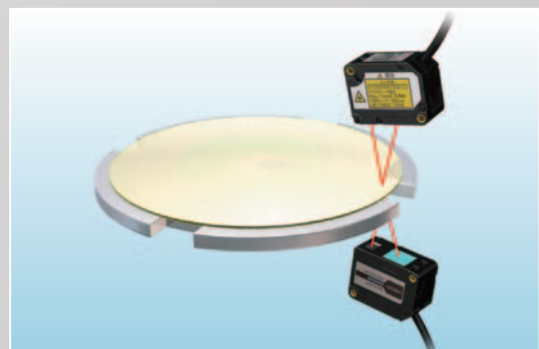


Point

Even if the color of the substrate changes, application of the HSDR-CMOS image sensor and Omron's proprietary algorithm results in almost no fluctuation in measured value.

Thickness

Wafer thickness
measurement



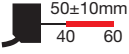
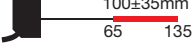
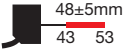
Point

You can easily measure thicknesses by using Regular-reflective Sensor Heads and connecting a Calculating Unit between the two Amplifier Units to perform calculations.

Ordering Information

Units

Sensor Heads [\[Dimensions → page 14\]](#)

Appearance	Optical system	Beam shape	Sensing distance	Resolution	Model
	Diffuse reflective	Line beam	 50±10mm 40 60	1.5μm	ZX2-LD50L 0.5M
		Spot beam			ZX2-LD50 0.5M
		Line beam	 100±35mm 65 135	5μm	ZX2-LD100L 0.5M
		Spot beam			ZX2-LD100 0.5M
	Regular reflective	Spot beam	 48±5mm 43 53	1.5μm	ZX2-LD50V 0.5M

Amplifier Units [\[Dimensions → page 14\]](#)

Appearance	Power supply	Output type	Model
	DC	NPN	ZX2-LDA11 2M
		PNP	ZX2-LDA41 2M

Accessories (sold separately) These are not included with the Sensor Head or Amplifier Unit. Please order as necessary.

Calculating Unit [\[Dimensions → page 14\]](#)

Appearance	Model
	ZX2-CAL

Communications Interface Unit [\[Dimensions → page 14\]](#)

Appearance	Type	Model
	RS-232C	ZX2-SF11

Sensor Head Extension Cables [\[Dimensions → page 14\]](#)

Cable Length	Model
1m	ZX2-XC1R
4m	ZX2-XC4R
9m	ZX2-XC9R
20m	ZX2-XC20R

* Extension cables cannot be coupled and used together.

Mounting Brackets [\[Dimensions → page 15\]](#)

Applicable Sensor Heads	Appearance	Model	Contents
ZX2-LD50V ZX2-LD50L ZX2-LD50		E39-L178	Mounting Bracket: 1 Nut plate: 1 Phillips screws (M3×30): 2
ZX2-LD100L ZX2-LD100		E39-L179	

Diffuse-reflective Sensor Heads

Item	Model	ZX2-LD50L	ZX2-LD50	ZX2-LD100L	ZX2-LD100
Optical system	Diffuse reflective				
Light source (wave length)	Visible-light semiconductor laser with a wavelength of 660 nm and an output of 1mW max.				
Laser class	Class 1 (JIS, IEC/EN, FDA *5, GB/T)				
Measurement center point	50mm			100mm	
Measurement range	±10mm			±35mm	
Beam shape	Line		Spot		Spot
Beam size *1	Approx. 60μm×2.6mm		Approx. 60μm dia.		Approx.110μm×2.7mm
Resolution *2	1.5μm			5μm	
Linearity *3	±0.05%F.S. (40 to 50mm) ±0.1%F.S. (entire range)		±0.1%F.S. (40 to 50mm) ±0.15%F.S. (entire range)		±0.05%F.S. (65 to 100mm) ±0.1%F.S. (entire range)
Temperature characteristic *4	0.02%F.S./°C				
Ambient illumination	Incandescent lamp: 10,000lx max. (on light receiving side)				
Ambient temperature	Operating: 0 to +50°C, Storage: -15 to +70°C (with no icing or condensation)				
Ambient humidity	Operating and storage: 35% to 85% (with no condensation)				
Dielectric strength	1,000 VAC, 50/60 Hz for 1 minute				
Vibration resistance (destruction)	10 to 150 Hz, 0.7-mm double amplitude, 80 minutes, each in X,Y,and Z directions				
Shock resistance (destruction)	300 m/s² 3 times each in six directions (up/down,left/right,forward/backward)				
Degree of protection	IEC60529, IP67				
Connection method	Connector connection (standard cable length: 500 mm)				
Weight (packed state)	Approx.160g (Sensor Head only: Approx.75g)				
Materials	Case and cover: PBT (polybutylene terephthalate), Optical window: Glass, Internal thread: Brass, Cable: PVC				
Accessories	Instruction sheet, Ferrite core ×1 (made by TDK Corp. ZCAT1730-0730A), Laser explanatory label (English), FDA certification label				

Regular-reflective Sensor Head

Item	Model	ZX2-LD50V
Optical system	Regular reflective	
Light source (wave length)	Visible-light semiconductor laser with a wavelength of 660 nm and an output of 0.24 mW max.	
Laser class	Class 1 (JIS, IEC/EN, FDA *5, GB/T)	
Measurement center point	48mm	
Measurement range	±5mm	
Beam shape	Spot	
Beam size *1	Approx. 60μm dia.	
Resolution *2	1.5μm	
Linearity *3	±0.3%F.S. (entire range)	
Temperature characteristic *4	0.06%F.S./°C	
Ambient illumination	Incandescent lamp: 10,000lx max. (on light receiving side)	
Ambient temperature	Operating: 0 to +50°C, Storage: -15 to +70°C (with no icing or condensation)	
Ambient humidity	Operating and storage: 35% to 85% (with no condensation)	
Dielectric strength	1,000 VAC, 50/60 Hz for 1 minute	
Vibration resistance (destruction)	10 to 150 Hz, 0.7-mm double amplitude, 80 minutes, each in X,Y,and Z directions	
Shock resistance (destruction)	300 m/s² 3 times each in six directions (up/down,left/right,forward/backward)	
Degree of protection	IEC 60529, IP67	
Connection method	Connector connection (standard cable length: 500 mm)	
Weight (packed state)	Approx.160g (Sensor Head only: Approx.75g)	
Materials	Case and cover: PBT (polybutylene terephthalate), Optical window: Glass, Internal thread: Brass, Cable: PVC	
Accessories	Instruction sheet, Ferrite core ×1 (made by TDK Corp. ZCAT1730-0730A), Laser explanatory label (English), FDA certification label	

Note) False detection outside the measurement range can occur in the case of an object with high reflectance.

*1. Beam size: Defined as 1/e² (13.5%) of the central intensity at the smallest value of diameter for the measurement range (typical value)

False detections can occur in the case there is light leakage outside the defined region and the surroundings of the target object have a high reflectance in comparison to the target object.

*2. Resolution: indicates the degree of fluctuation (±3σ) of analog output when connected to the ZX2-LDA.

(The measured value is given for the center distance for OMRON's standard target object (diffuse-reflective models: white ceramic object, regular-reflective models: 1/4 λ flat mirror) when the response time of the ZX2-LDA is set to 128 ms.)

Indicates the repetition accuracy for when the workpiece is in a state of rest. Not an indication of distance accuracy.

Resolution performance may not be satisfied in a strong electromagnetic field.

*3. Linearity: indicates the error with respect to the ideal straight line of the displacement output in the case of measuring Omron's standard target object. Linearity and measured value may vary depending on target object.

F.S. indicates the full scope of the measurement range. (ZX2-LD50 (L): 20mm)

*4. Temperature characteristic: Value for the case the space between the sensor head and Omron's standard target object is secured by an aluminum jig. (Measured at the measurement center distance)

*5. These Sensors are classified as Class 1 under IEC 60825-1: 2014 and the regulations of Laser Notice No. 56 for FDA certification. CDRH registration has been completed. Accession Number: 1020665-003

Amplifier Units

Item	Model	ZX2-LDA11	ZX2-LDA41
Measurement period *1		Min. 30μs	
Response time		60μs, 120μs, 240μs, 500μs, 1ms, 2ms, 4ms, 8ms, 12ms, 20ms, 36ms, 66ms, 128ms, 250ms, 500ms	
Analog output *2		4 to 20 mA, Max. load resistance: 300Ω, ±5VDC or 1 to 5 VDC, Output impedance: 100Ω	
Judgement outputs (HIGH/PASS/LOW: 3 outputs), error output		NPN open-collector outputs, 30 VDC, 50 mA max. (residual voltage: 1V max. for load current 10mA max., 2V max. for load current above 10mA)	PNP open-collector outputs, 30 VDC, 50 mA max. (residual voltage: 1V max. for load current 10mA max., 2V max. for load current above 10mA)
Laser OFF input, zero reset input, timing input, reset input, bank input		ON: Short-circuited with 0-V terminal or 1.2V or less OFF: Open (leakage current: 0.1 mA max.)	ON: Supply voltage short-circuited or supply voltage within -1.2V OFF: Open (leakage current: 0.1 mA max.)
Functions		Smart tuning, scaling, sample hold, peak hold, bottom hold, peak-to-peak hold, self-peak hold, self-bottom hold, average hold, zero reset, On-delay timer, OFF-delay timer, keep/clamp switch, (A-B)calculations *3, thickness calculation *3, mutual interference prevention *3, laser deterioration detection, bank function(4 banks), differential function	
Indications		Judgement indicators: HIGH(orange),PASS(green),LOW(orange),11-segment main display(red),11-segment sub-display(orange),laser ON(green),zero reset(green),enable(green),menu(green), HIGH threshold(orange),LOW threshold(orange)	
Power supply voltage		10 to 30 VDC, including 10% ripple(p-p)	
Power consumption		3,000 mW max. (at 24 VDC: 125 mA max., at 12 VDC: 250 mA max.)	
Ambient temperature		Operating: 0 to +50°C, Storage: -15 to +70°C (with no icing or condensation)	
Ambient humidity		Operating and storage: 35% to 85% (with no condensation)	
Dielectric strength		1,000 VAC, 50/60 Hz for 1 minute	
Vibration resistance (destruction)		10 to 150 Hz, 0.7-mm double amplitude, 80 minutes, each in X,Y,and Z directions	
Shock resistance (destruction)		300 m/s ² 3 times each in six directions (up/down,left/right,forward/backward)	
Degree of protection		IEC60529, IP40	
Connection method		Prewired (standard cable length: 2 m)	
Weight (packed state)		Approx.200g (Amplifier Unit only: Approx.135g)	
Materials		Case: PBT (polybutylene terephthalate), Cover: Polycarbonate, Display: Methacrylic resin, Button: Polyacetal, Cable: PVC	
Accessories		Instruction sheet	

*1. In the case of Omron's standard target object (white ceramic)

*2. Configure current output (4 to 20mA) and voltage output (±5V or 1 to 5V) by MENU mode.

*3. Calculating unit (ZX2-CAL) is necessary. Calculations are possible for two amplifier units. Mutual interference prevention is possible for up to five amplifier units.

Calculating Unit

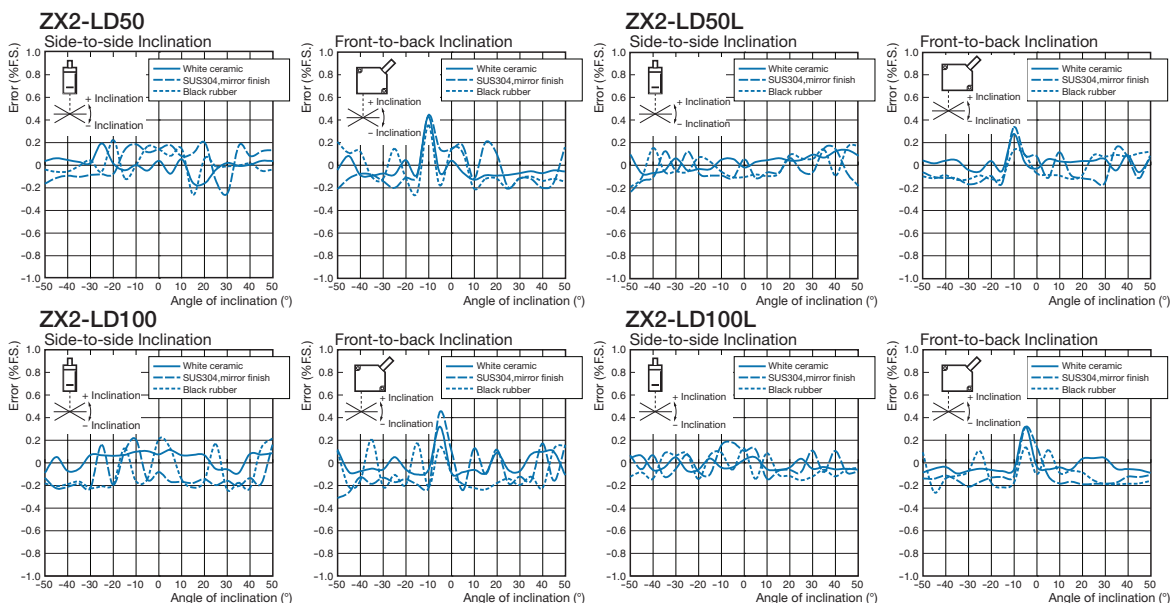
Item	Model	ZX2-CAL
Applicable Amplifier Units		ZX2-LDA11, ZX2-LDA41
Current consumption		12 mA max. (supplied from the Smart Sensor Amplifier Unit)
Ambient temperature		Operating: 0 to +50°C, storage: -15 to +70°C (with no icing or condensation)
Ambient humidity		Operating and storage: 35% to 85% (with no condensation)
Connection method		Connector
Dielectric strength		1,000 VAC, 50/60 Hz for 1 minute
Vibration resistance (destructive)		10 to 150 Hz, 0.7-mm double amplitude, 80 minutes, each in X,Y,and Z directions
Shock resistance (destructive)		300 m/s ² 3 times each in six directions (up/down, left/right, forward/backward)
Materials		Case: ABS, Display: Methacrylic resin
Weight (packed state)		Approx. 50g (Calculating Unit only: Approx. 15g)
Accessories		Instruction sheet

ZX2-series Communications Interface Unit

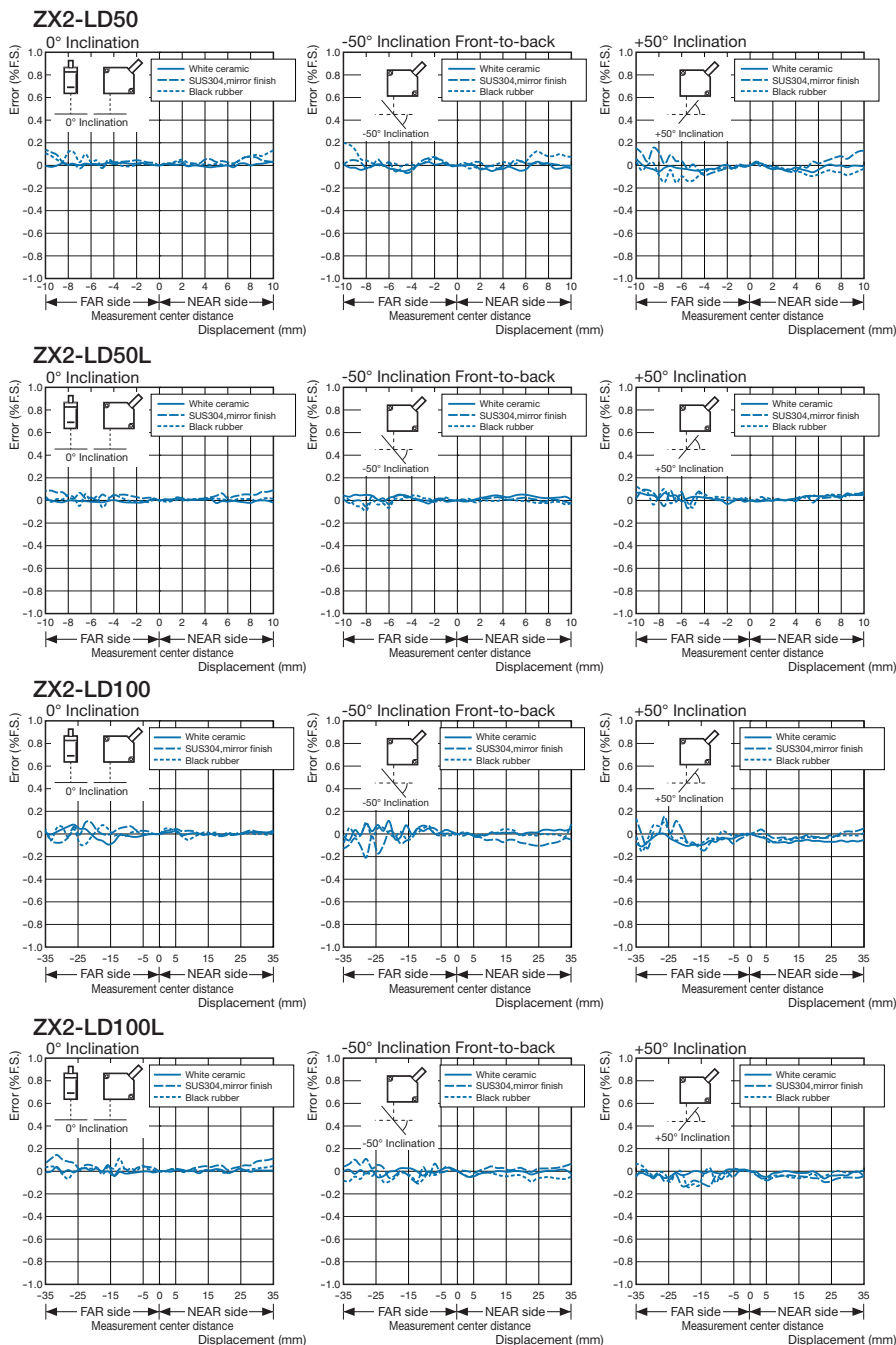
Item	Model	ZX2-SF11
Power supply voltage		10 to 30 V DC ±10% (including 10% ripple (p-p)) (Supplied from Sensor Amplifier.)
Power consumption		720 mW max. (at 24 V: 30 mA max., at 12 V: 60 mA max.) (Not including Sensor Amplifier current consumption or output current.)
Applicable Amplifier Units		ZX2-LDA□□ (Production after November 2013)
Applicable Amplifier Unit versions		Sensor Amplifier Unit version: V1.330 or higher (The Sensor Amplifier version is shown on the sub-digital display when the power of the Sensor Amplifier is turned ON.)
Max. No. of Amplifier Units		5
Communications functions	Port	RS-232C (9-pin, D-Sub connector)
	Communications method	Full duplex
	Synchronization method	Start/stop synchronization
	Transmission code	ASCII
	Baud rate	38,400 (at shipping)/9,600 bps switchable
	Data bit length	8 bits
	Parity check	None
	Stop bit length	1 bit
	Data delimiter	Receiving CR or CR + LF is automatically recognized. Sending CR + LF fixed
Indicators		Power supply: green, Sensor communications: green, Sensor communications error: red, External terminal communications: green, External terminal communications error: red
Protective circuits		Power supply reverse polarity protection
Ambient temperature		Operating: 0 to 50°C, storage: -15 to 60°C (with no icing or condensation)
Ambient humidity		Operating and storage: 35% to 85% (with no condensation)
Insulation resistance		20 MΩ min. (at 500 VDC)
Dielectric strength		1,000 VAC, 50/60 Hz for 1 min, Leakage current: 10 mA max.
Materials		Case: PBT (polybutylene terephthalate), Cover: Polycarbonate
Accessories		Instruction sheet, 2 clamps

Engineering Data (Reference Value)

Angle Characteristic



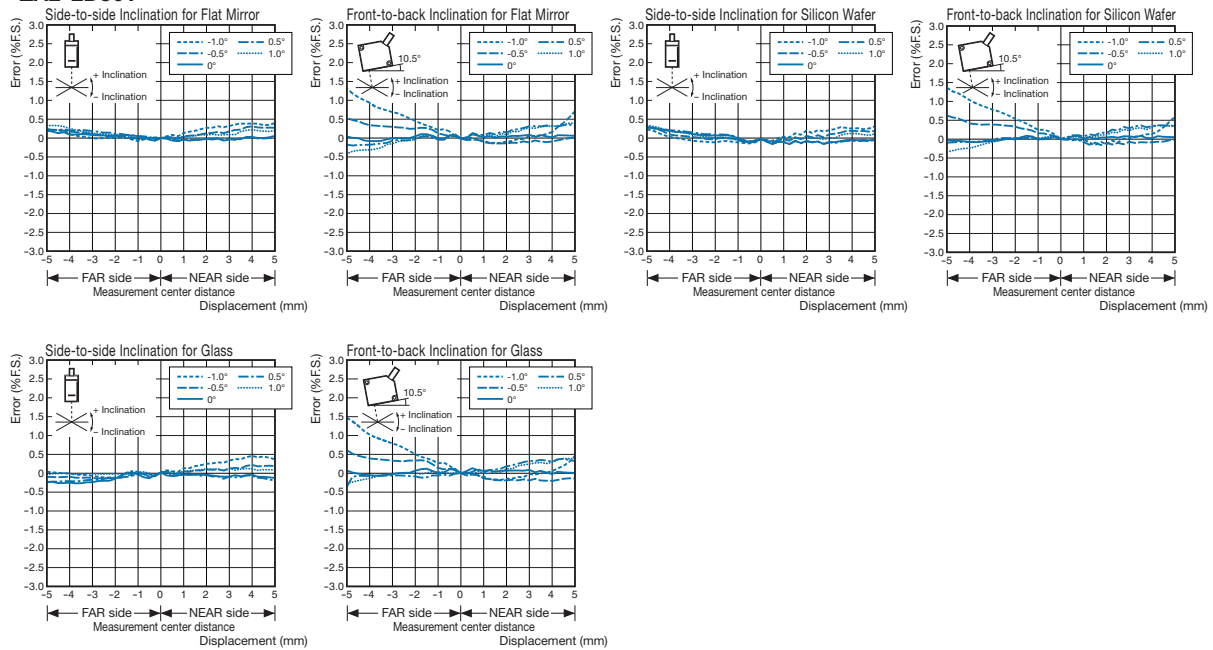
Linearity Characteristic for Different Materials



* The x-axis displacement indicates the measurement distance displayed by the amplifier unit. The measurement distance displayed by the amplifier unit takes the measurement center distance as 0 and displays the near-side from the sensor as plus and the far-side as minus.

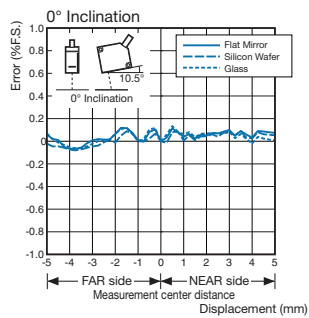
Angle Characteristic

ZX2-LD50V



Linearity Characteristic for Different Materials

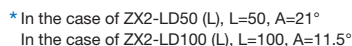
ZX2-LD50V



* The x-axis displacement indicates the measurement distance displayed by the amplifier unit. The measurement distance displayed by the amplifier unit takes the measurement center distance as 0 and displays the near-side from the sensor as plus and the far-side as minus.

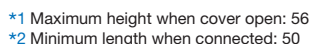
(Unit: mm)

ZX2-LD50/ZX2-LD50L
ZX2-LD100/ZX2-LD100L
ZX2-LD50V

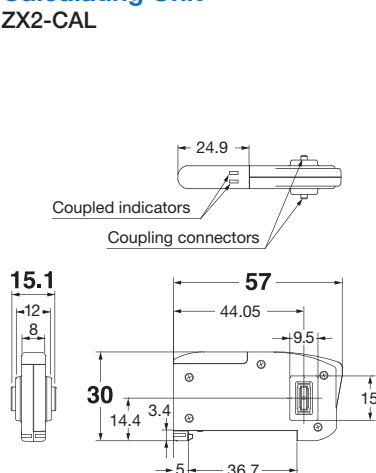


Note: Attach the enclosed ferrite core (16.5 dia., length: 30 mm) to the cable within 100 mm from the Sensor Head.

ZX2-LDA11/ZX2-LDA41



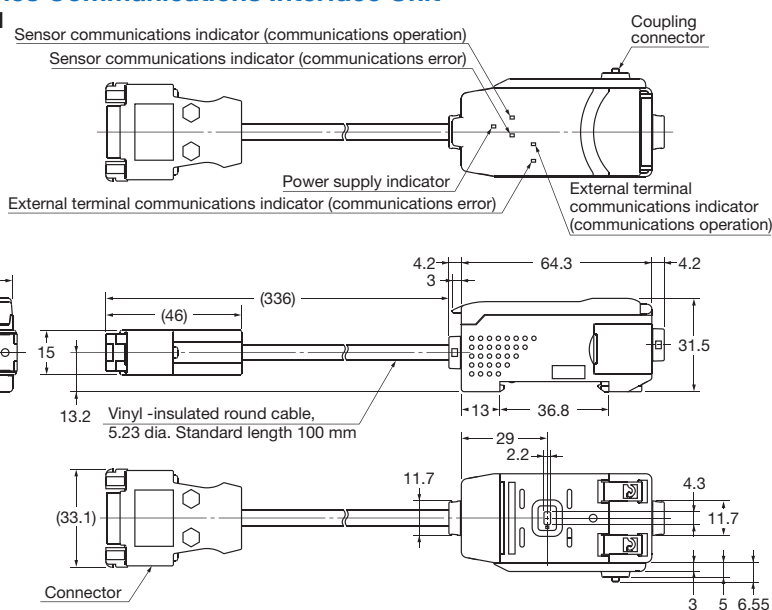
ZX2-CAL



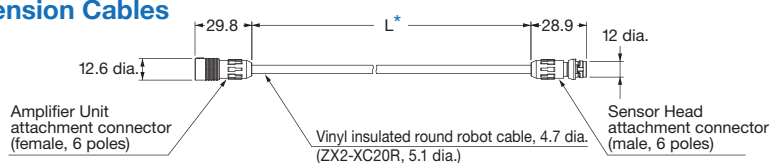
ZX2-SF11

Sensor communications indicator (communications operation)

Sensor communications indicator (communications error)



ZX2-XC1R
ZX2-XC4R
ZX2-XC9R
ZX2-XC20R

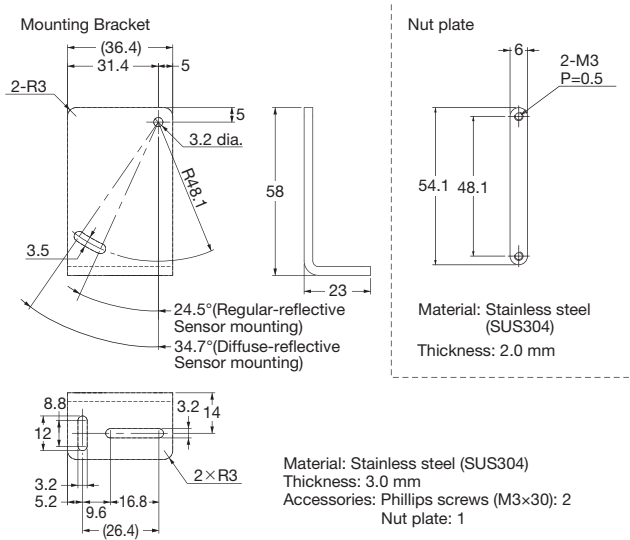


* Length L is as follows.

Length L is as follows:
ZX2-XC1R:1 m, ZX2-XC4R:4 m,
ZX2-XC9R:9 m, ZX2-XC20R:20 m
Minimum bending radius: 30 mm

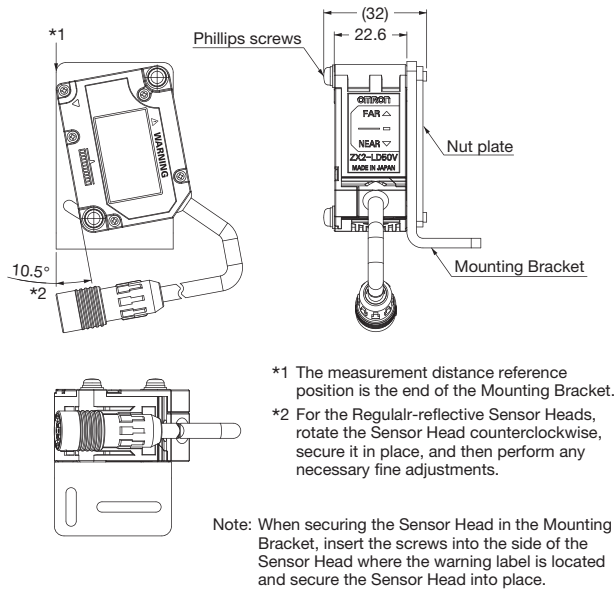
Note: Attach the enclosed ferrite cores (16.5 dia., length: 30 mm) within 100 mm of each end of the extension cable.

Mounting Bracket E39-L178



Installation Method for Regular-reflective Sensor Head

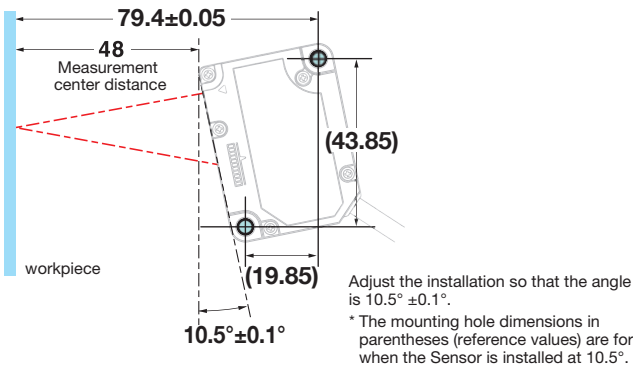
Using a E39-L178 Mounting Bracket:



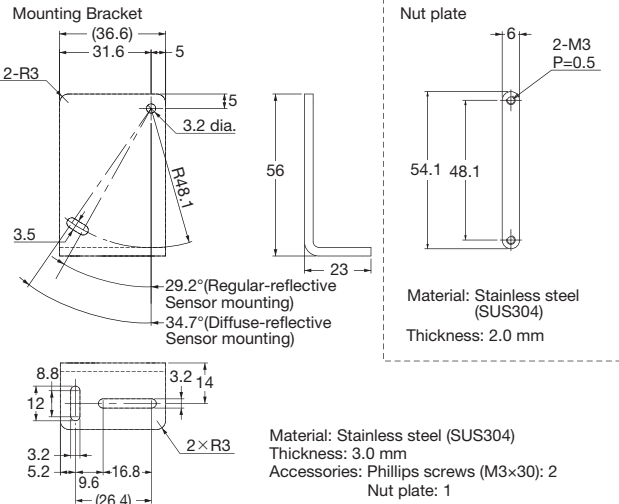
Not Using a Mounting Bracket:

Tilt the Sensor Head towards the workpiece as shown below.

ZX2-LD50V



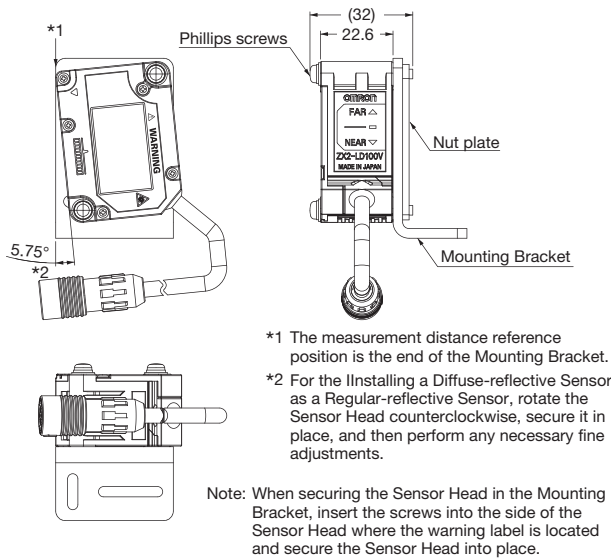
Mounting Bracket E39-L179



* Use this Mounting Bracket when installing the ZX2-LD100 (L) as a normal Diffuse-reflective or Regular-reflective Sensor Head.

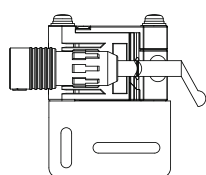
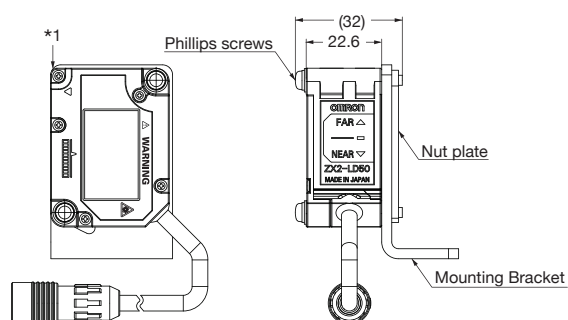
Installation Method for Regular-reflective Sensor Heads (Installing a Diffuse-reflective Sensor Head as a Regular-reflective Sensor Head)

Using a E39-L179 Mounting Bracket:



Installation Method for Diffuse-reflective Sensor Heads

Using a E39-L178, E39-L179 Mounting Bracket:

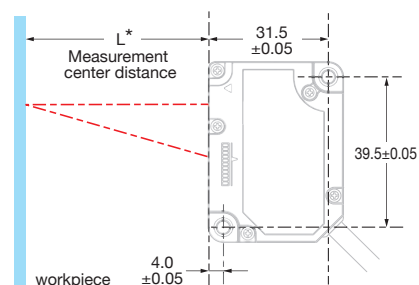


*1 The measurement distance reference position is the Sensor's sensing surface.

Note: When securing the Sensor Head in the Mounting Bracket, insert the screws into the side of the Sensor Head where the warning label is located and secure the Sensor Head into place.

Not Using a Mounting Bracket:

Mount the Sensor Head in relation to the workpiece as shown below.



* ZX2-LD50 (L): 50
ZX2-LD100 (L): 100

Note: Do not use this document to operate the Unit.

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